

GENERAL DESCRIPTION

OB3600 is a dimmable, highly integrated buck regulator with advanced features to provide high efficiency control and high precision constant current output for LED lighting applications.

Proprietary Constant Voltage (CV) and Constant Current (CC) control is integrated as shown in the figure below.

The LED current (CC control) can be adjusted externally by the resistor Rs at CS pin.

OB3600 offers a dimmable function, the LED current can be controlled by setting the duty cycle of PWM waveform into the DC pin.

OB3600 offers comprehensive protection coverage with auto-recovery features including Cycle-by-Cycle current limiting, VDD OVP and UVLO. Excellent EMI performance is achieved with On-Bright proprietary frequency shuffling technique.

OB3600 is offered in SOP8 package.

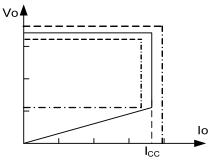


Fig.1. Typical CC/CV Curve

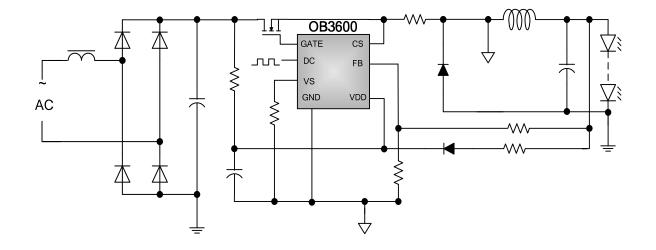
TYPICAL APPLICATION

FEATURES

- High Precise Constant Current Regulation at Universal AC input
- Dimmable LED Current Control
- Quasi-Resonant operation
- Adjustable Constant Current, Constant Voltage
- Built-in Primary winding inductance compensation
- LED short circuit protection
- Built-in Leading Edge Blanking (LEB)
- Cycle-by-Cycle Current Limiting
- VDD Under Voltage Lockout with Hysteresis (UVLO)
- Latched over temperature protection (OTP)
- VDD OVP

APPLICATIONS

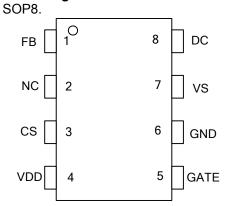
Dimmable LED lighting





GENERAL INFORMATION

Pin Configuration



Ordering Information

Part Number	Description
OB3600CP	SOP8, Pb-free in Tube
OB3600CPA	SOP8, Pb-free in T&R

Package Dissipation Rating

Package	RθJA (℃/W)
SOP8	150

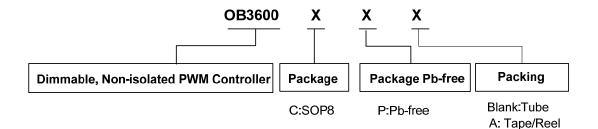
Absolute Maximum Ratings

Parameter	Value		
Gate Voltage	-0.3 to 25V		
VDD Voltage	-0.3 to V _{DD} OVP		
CS, FB, VS and DC Input Voltage	-0.3 to 7V		
Min/Max Operating Junction Temperature T _J	-40 to 155 ℃		
Operating Ambient Temperature T _A	-40 to 85 ℃		
Min/Max Storage Temperature	- 55 to 155 ℃		
Lead Temperature (Soldering, 10secs)	260 ℃		

Note: Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute maximum-rated conditions for extended periods may affect device reliability.

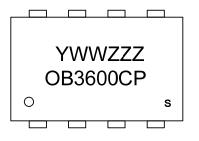
Recommended Operating Condition

Symbol	Parameter	Range
VDD	VDD Supply Voltage	12 to 25 V





Marking Information



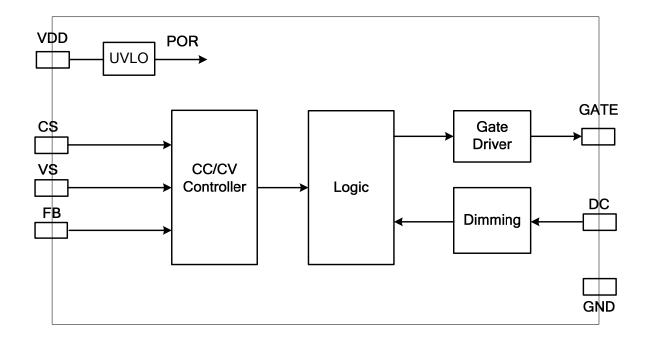
Y:Year Code WW:Week Code(01-52) ZZZ:Lot Code C:SOP8 Package P:Pb-free Package S:Internal Code(Optional)

TERMINAL ASSIGNMENTS

Pin Num	Pin Name	I/O	Description
1	FB	I/O	Connected to resistor divider from primary winding or auxiliary winding to reflect output voltage
2	NC		No Connection
3	CS	I/O	Current Sense Input
4	VDD	Р	Power Supply
5	GATE	0	Gate Driver Output
6	GND	Р	Ground
7	VS	I/O	Dimming ON voltage reference select
8	DC	I/O	Dimming Control Input



BLOCK DIAGRAM





ELECTRICAL CHARACTERISTICS

(TA = 25° C, VDD=16V, if not otherwise noted)

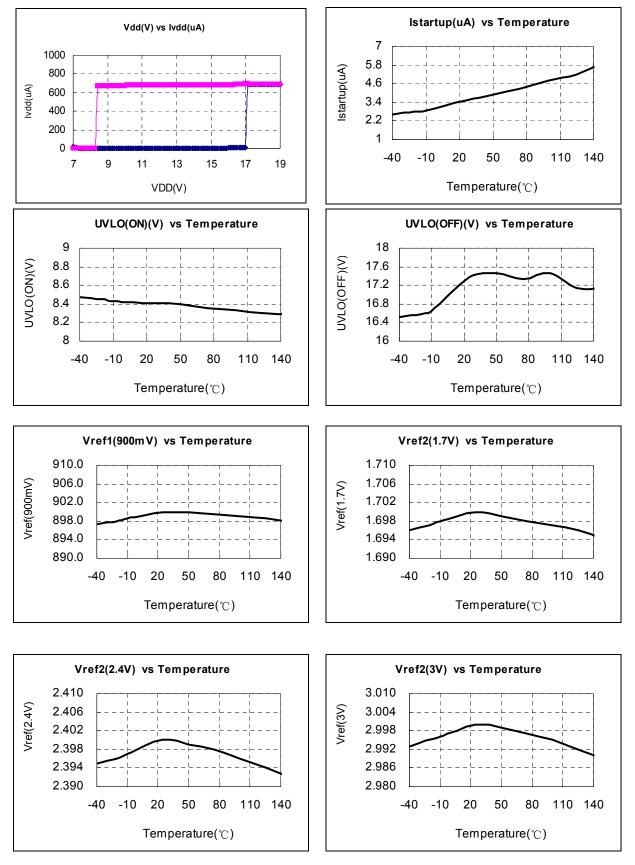
Parameter ge (VDD) section Startup Current Operation Current	Test Conditions VDD=UVLO_OFF-1V Operation supply current		Typ.	Max	Unit
Startup Current	Operation supply current		4		
•	Operation supply current			20	uA
	FB=1V, CS=0V, VDD= 20V	-	0.45	1	mA
VDD Under Voltage Lockout Enter	VDD falling	7.3	8.3	9.3	V
VDD Under Voltage Lockout Exit	VDD rising	15.5	16.5	17.5	V
VDD over voltage protection		26	27	28.5	V
e Input section					
LEB time			500		ns
Over current threshold		492	500	508	mV
OCP Propagation delay			100		ns
IC Maximum frequency		144			KHz
Minimum Toff			2.0		us
Minimum frequency			114		Hz
Frequency shuffling range			±3.5		%
er section					
		0.85	0.9	0.95	V
~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~	Vs should be connected to GND			1.78	V
Reference voltage 2 for EA	Vs should be floated	2.28	2.4	2.52	V
	Vs should connect a resistor to GND	2.85	3	3.15	V
DC gain of EA			40		
	Vs should be connected to GND		1.9		V
Load OVP threshold voltage	Vs should be floated		2.7		V
	Vs should connect a resistor to GND		3.3		V
Voltage reference select resistor @ Vref2=3V			270		KΩ
ection					
Output low level @ VDD=14V, lo=5mA				1	V
Output high level @ VDD=14V, lo=20mA		6			V
Output clamp voltage			10		V
			95		ns
Output falling time 9V~1V@ CL=500pF			50		ns
temperature section					
Over temperature protection trigger point			155		°C
trol section		,	,		
Threshold voltage for rising edge detection for DC pin		0.85	1	1.15	V
Threshold voltage for falling edge detection for DC pin		2.55	3	3.45	V
	VDD over voltage protection e Input section LEB time Over current threshold OCP Propagation delay ection IC Maximum frequency Minimum Toff Minimum Toff Minimum frequency Frequency shuffling range er section Reference voltage 1 for EA Reference voltage 2 for EA DC gain of EA Load OVP threshold voltage Voltage reference select resistor @ Vref2=3V ection Output low level @ VDD=14V, lo=5mA Output high level @ VDD=14V, lo=5mA Output clamp voltage Output rising time 1V~ 9V@ CL=500pF Output falling time 9V~1V@ CL=500pF temperature section Over temperature protection trigger point trol section Threshold voltage for rising edge detection for DC pin Threshold voltage for falling edge	VDD over voltage protection       Imput section         LEB time       Over current threshold       OCP Propagation delay         OCP Propagation delay       Imput section       IC         IC Maximum frequency       Imput section       IC         Minimum Toff       Imput section       IC         Minimum frequency       Imput section       IC         Frequency shuffling range       Imput section       Imput section         Reference voltage 1 for EA       Vs should be connected to GND         Reference voltage 2 for EA       Vs should be floated         Vs should be floated       Vs should be connected to GND         DC gain of EA       Vs should be connected to GND         Load OVP threshold voltage       Vs should be floated         Vs should be floated       Vs should be floated         Vs should be floated       Vs should be floated         Vs should be floated       Vs should connect a resistor to GND         Voltage reference select resistor @       Vs should connect a resistor to GND         Votage reference select resistor @       Output figh level @ VDD=14V, lo=5mA         Output low level @ VDD=14V, lo=5mA       Output trising time 1V~ 9V@ CL=500pF         Output figh gring time 9V~1V@ CL=500pF       Output failing time 9V~1V@ CL=500pF         Output fighing time 9V~	VDD over voltage protection       26         e Input section	VDD over voltage protection         26         27           e Input section         500           Over current threshold         492         500           OCP Propagation delay         100         100           section         1144         100           CMaximum frequency         1144         1144           Minimum Toff         2.0         1144           Frequency shuffling range         ±3.5         114           Frequency shuffling range         114         1.62           Reference voltage 1 for EA         0.85         0.9           Reference voltage 2 for EA         Vs should be connected to GND         1.62         1.7           Vs should connect a resistor to GND         2.85         3         3           DC gain of EA         Vs should be floated         2.7         Vs should connect a resistor to GND         1.9           Load OVP threshold voltage         Vs should connect a resistor to GND         3.3         3         3           Voltage reference select resistor @         270         270         270           ection         0         10         0         0           Output low level @ VDD=14V, lo=5mA         0         0         0           lo=20mA	VDD over voltage protection         26         27         28.5           e Input section         500         500           LEB time         500         500           Over current threshold         492         500         508           OCP Propagation delay         100         state         500         508           OCP Propagation delay         100         state         500         508           OCP Propagation delay         144         100         state         state         500         508           OCP Propagation delay         144         144         144         144         144         144         144         144         144         144         144         144         144         144         144         144         144         144         144         144         144         144         144         144         144         144         144         144         144         144         144         144         144         144         144         144         144         144         144         144         144         144         144         144         144         144         144         144         144         144         144         144

#### Note:

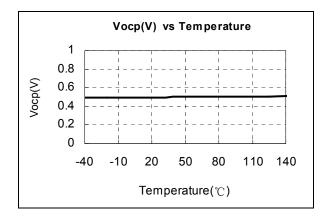
1. Freq_Max indicates IC internal maximum clock frequency. In system application, the maximum operation frequency of 144 KHz nominal occurs at maximum output power or the transition point from CV to CC.



# CHARACTERIZATION PLOTS









## **OPERATION DESCRIPTION**

OB3600 is a dimmable, non-isolated LED lighting controller which can achieve accurate current for LED lighting applications. Proprietary Constant Voltage (CV) and Constant Current (CC) control is integrated.

#### Startup Current and Start up Control

Startup current of OB3600 is designed to be very low so that VDD could be charged up above UVLO threshold and starts up quickly. A large value startup resistor can therefore be used to minimize the power loss in application.

#### **Operating Current**

The Operating current of OB3600 is as low as 0.45mA (Typ.). Typical good efficiency is achieved with the low operating current.

#### **Principle of CC Operation**

For buck type operating in transition mode, the peak voltage of CS is detected cycle-by-cycle, and compared with internal reference voltage, Vth_ocp (typical value 500mV).When the voltage at CS pin is up to the threshold voltage, the power switch will be turned off.

$$I_{pk} = \frac{V_{th_ocp}}{R_{CS}} \tag{1}$$

Where, Rcs indicates the resistor at CS pin for primary side current sensing.

Refer to the equation 1, LED output current is

$$ILED = \frac{I_{pk}}{2} = \frac{V_{th_ocp}}{2 \times R_{CS}}$$
⁽²⁾

OB3600 works under transition mode and the on-time for power switch is

$$ton = \frac{L \times I_{pk}}{V_{pk}} \tag{3}$$

Vin-VLED

Where L is the inductor of transformer at primary-side winding, Vin is line voltage after rectifying and  $V_{LED}$  is the voltage at LED.

When power switch turns off, the current flowing in the inductor will reduce to zero and the power switch will turn on after then. The off-time for power switch is

$$t_{off} = \frac{L \times I_{pk}}{V_{LED}} \tag{4}$$

The inductor could also be calculated by

$$L = \frac{V_{LED} \times (V_{in} - V_{LED})}{f \times I_{pk} \times V_{in}}$$
(5)

Where, f is the working frequency. The working frequency changes with input voltage. The lowest input voltage determines the lowest

working frequency and the highest input voltage determines the highest working frequency.

The minimum and maximum off-time are set in OB3600. Therefore, the value of inductor should be carefully designed to achieve good LED output current, according to equation 4.

#### Adjustable CC point and Output Power

In OB3600, the CC point and maximum output power can be externally adjusted by external current sense resistor Rs at CS pin as illustrated in Typical Application Diagram. The output power is adjusted through CC point change. The larger Rs, the smaller CC point is, and the smaller output power becomes, and vice versa as shown in Fig.1.

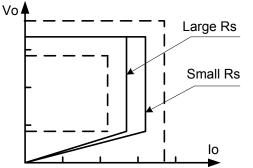


Figure.1 Adjustable output power by changing Rs

#### Operation switching frequency

The switching frequency of OB3600 is adaptively controlled according to the load conditions and the operation modes. No external frequency setting components are required. The operation switching frequency at maximum output power is set to 144KHz internally.

For buck operating in QR, The maximum output power is given by

$$P_{O\max} = \frac{1}{2} \eta L_{P} F_{SW} I_{pk}^{2}$$
 (4)

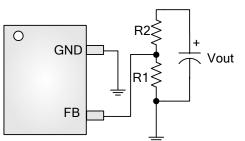
Where Lp indicate the inductance of winding and lpk is the peak current of winding.

The principle of CC operation sets the product Lp and *fsw* to be a constant, thus the maximum output power and constant current in CC mode will not change as primary winding inductance changes. Up to +/-7% variation of the primary winding inductance can be compensated.

#### CV / OVP Mode

When LED string is open, an output voltage condition is monitored independently by the voltage at FB pin. During normal operation, the voltage at FB pin is regulated at 0.9 or 2.4V (VS pin floating), with dummy load over Pmin.





OB3600

Figure.2 FB Section Circuit

$$V_{OUT} = \frac{R1 + R2}{R1} \times V_{ref_{-}CV}$$
$$P_{\min} = \frac{1}{2} \times \left(\frac{Vth_{-}oc}{R_{CS}}\right)^2 F_{\min} L_{priamry}$$

 $V_{\text{th_oc}}$  — Over current protection threshold voltage

 $F_{min}$  — Minimum switching frequency, which is 103Hz (typ.)

If the dummy load is less than  $P_{min}$ , the output voltage rises up. If the voltage at FB pin exceeds a threshold of approximately 2.7V (VS pin floating), the over-voltage protection function is activated and the switching is turned off immediately.

$$V_{OVP} = \frac{R1 + R2}{R1} \times V_{vth_OVP}$$

## **CC Line Regulation**

Adjust the R2 for better CC line regulation, while driving different type MOSFET. The larger MOSFET, the smaller R2 needed. If the resistance is too large, it causes the interference, too small resistance results the efficiency decreased at HV AC line.

#### Frequency shuffling for EMI improvement

The frequency shuffling (switching frequency modulation) is implemented in OB3600. The oscillation frequency is modulated so that the tone energy is spread out. The spread spectrum minimizes the conduction band EMI and therefore eases the system design.

## **Current Sensing and Leading Edge Blanking**

Cycle-by-Cycle current limiting is offered in OB3600. The switch current is detected by a sense resistor into the CS pin. An internal leading edge blanking circuit chops off the sensed voltage spike at initial power MOSFET on state so that the external RC filtering on sense input is no longer needed.

## **Protection Control**

Good power supply system reliability is achieved with its rich protection features including Cycle-by-Cycle current limiting (OCP), VDD OVP, on-chip OTP, and Under Voltage Lockout on VDD (UVLO).

## Latched Over Temperature Protection

Over temperature protection is offered in OB3600. When temperature of the device rises over  $155^{\circ}$ C (typical), the switching frequency will decrease to half. And the state will be kept until the device restarts.

## UVLO

VDD is supplied by transformer winding output. The output of OB3600 is shut down when VDD drops below UVLO (ON) limit and the power converter enters power on start-up sequence thereafter.

# Dimming (Error Amplifier Reference Voltage Switch) Control

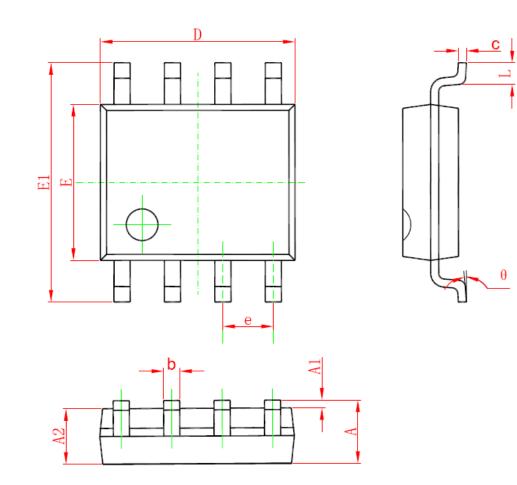
Dimming (Error Amplifier Reference Voltage switch) control is offered in OB3600. Default the DC pin is pulled up with 1mA current source. The error amplifier reference voltage is 0.9V. If the DC pin is pulled down, the error amplifier reference voltage is switched to 2.4V (VS pin floating). Dimming ON voltage reference offering pin programmable selection of three popular voltage 1.7V, 2.4V, 3V. The connecting of the programming pin as shown in table:

VS pin connecting	Vref2	Vth_OVP
Connecting to GND	1.7V	1.9V
Floating	2.4V	2.7V
Connecting to GND with 270K resistor	3V	3.3V



# PACKAGE MECHANICAL DATA

# SOP8 PACKAGE OUTLINE DIMENSIONS



Symbol	Dimensions	In Millimeters	Dimensions In Inches		
Symbol	Min	Max	Min	Max	
A	1.350	1.750	0.053	0.069	
A1	0.050	0.250	0.002	0.010	
A2	1.250	1.650	0.049	0.065	
b	0.310	0.510	0.012	0.020	
С	0.170	0.250	0.006	0.010	
D	4.700	5.150	0.185	0.203	
E	3.800	4.000	0.150	0.157	
E1	5.800	6.200	0.228	0.244	
e	1.270 (BSC)		0.05 (BSC)		
L	0.400	1.270	0.016	0.050	
θ	0°	8°	0°	8°	



# IMPORTANT NOTICE

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